(V) Preliminary Specifications

(   ) Final Specifications

Module	15.6" (15.55")HD Color TFT-LCD with LED Backlight design
Model Name	B156XW03 V0 (H/W:0A & 1A)
Note (💡)	*LED Backlight with driving circuit design*

Customer	Date
Checked & Approved by	**Date**

Note: This Specification is subject to change without notice.

Approved by	Date
Kendra Wang	02/19/2009
Prepared by	**Date**
Derrick Lee	02/19/2009

**NBBU Marketing Division /
AU Optronics corporation**

Contents

Record of Revision

Version and Date	Page	Old description	New Description	Remark
0.1　2008/12/11	All	First Edition for Customer		
0.2　2008/12/22	6	Color / Chromaticity Coordinates : TBD	Color / Chromaticity Coordinates updated	
	16	BLU Power 4.2W Max	BLU Power 4.13W Max	
	28	2D drawing	2D drawing / Diameter of Scew hole	
	31	EDID : TBD	EDID updated	
0.3　2009/1/20	20	Connector pluging diagram	Upward plugging	
	28	2D drawing	2D drawing / PCBA & bracket	
0.4　2009/2/5	6	Color / Chromaticity Coordinates	Color / Chromaticity Coordinates updated	
	13	Logic power 1.0W (Typ.) 1.2W (Max.)	Logic power 0.8W (Typ.) 1.05W (Max.)	
	28	2D drawing	2D drawing / bracket	
0.5　2009/2/19	28	2D drawing	2D drawing / Screw hole	

1. Handling Precautions

1) Since front polarizer is easily damaged, pay attention not to scratch it.

2) Be sure to turn off power supply when inserting or disconnecting from input connector.

3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.

4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.

5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.

6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.

7) Do not open nor modify the Module Assembly.

8) Do not press the reflector sheet at the back of the module to any directions.

9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.

10) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.

11) Small amount of materials having no flammability grade is used in the LCD Module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.

12) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostic breakdown.

2. General Description

B156XW01 V0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the HD (1366(H) x 768(V)) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B156XW03 V0 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 ℃ condition:

| Items	Unit	Specifications		
Screen Diagonal	[mm]	394.9 (15.55")		
Active Area	[mm]	344.2 x 193.5		
Pixels H x V		1366x3(RGB) x 768		
Pixel Pitch	[mm]	0.252 x 0.252		
Pixel Format		R.G.B. Vertical Stripe		
Display Mode		Normally White		
White Luminance (I_{LED}=20mA) (Note: I_{LED} is LED current)	[cd/m^2]	220 typ. (5 points average) 187 min. (5 points average)		
Luminance Uniformity		1.25 max. (5 points)		
Contrast Ratio		500 typ		
Response Time	[ms]	8 typ / 15 Max		
Nominal Input Voltage VDD	[Volt]	+3.3 typ.		
Power Consumption	[Watt]	5.4 max. (Include Logic and BLU power)		
Weight	[Grams]	425 max.		
Physical Size **without bracket.**	[mm]		Min.	Typ.	Max.
		Length	-	-	360
		Width	-	-	218
		Thickne	-	-	3.8
Electrical Interface		1 channel LVDS		
Glass Thickness	[mm]	0.5		
Surface Treatment		Glare, Hardness 3H, Reflection <5%		

| Support Color		262K colors (RGB 6-bit)

Temperature Range
  Operating
  Storage (Non-Operating)
	[°C]
	[°C]
		0 to +50
		-20 to +60

RoHS Compliance		RoHS Compliance

2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25℃ (Room Temperature) :

Item		Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
White Luminance I_{LED}=20mA			**5 points average**	187	220	-	cd/m²	1,4,5
Viewing Angle		$θ_R$ $θ_L$	**Horizontal (Right)** **CR = 10 (Left)**	40 40	45 45	- -	**degree**	4,9
		$ψ_H$ $ψ_L$	**Vertical (Upper)** **CR = 10 (Lower)**	10 30	15 35	- -		
Luminance Uniformity		$δ_{5P}$	**5 Points**	-	-	1.25		1,3,4
Luminance Uniformity		$δ_{13P}$	**13 Points**	-	-	TBD		2,3,4
Contrast Ratio		CR		400	500	-		4,6
Cross talk		%				4		4,7
Response Time		T_r	**Rising**	-	-	-	**msec**	4,8
		T_f	**Falling**	-	-	-		
		T_{RT}	**Rising + Falling**	-	8	15		
Color / Chromaticity Coodinates	**Red**	**Rx**	**CIE 1931**	0.590	0.620	0.650		4
		Ry		0.310	0.340	0.370		
	Green	**Gx**		0.300	0.330	0.360		
		Gy		0.540	0.570	0.600		
	Blue	**Bx**		0.120	0.150	0.180		
		By		0.030	0.060	0.090		
	White	**Wx**		0.263	0.313	0.363		
		Wy		0.279	0.329	0.379		
NTSC		%		-	60	-		

Note 1: 5 points position (Ref: Active area)
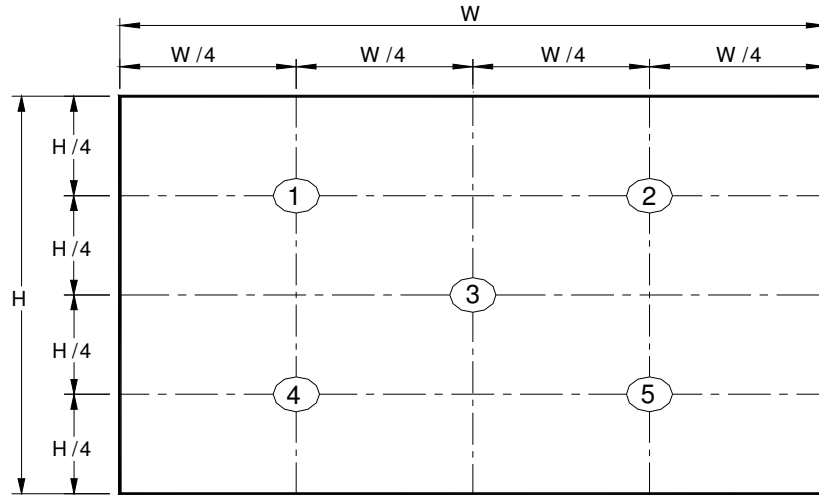
Note 2: 13 points position (Ref: Active area)
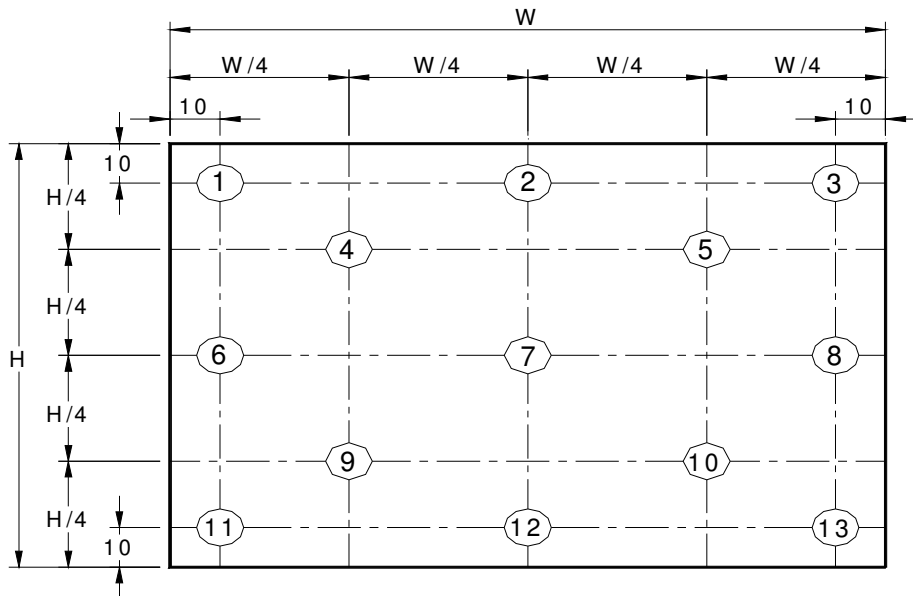
Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

$$\delta_{W5} = \frac{\text{Maximum Brightness of five points}}{\text{Minimum Brightness of five points}}$$

$$\delta_{W13} = \frac{\text{Maximum Brightness of thirteen points}}{\text{Minimum Brightness of thirteen points}}$$

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt

temperature change during measuring. In order to stabilize the luminance, the measurement should

be executed after lighting Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.

Photo detector

Field=2°

50 cm

LCD Panel

TFT-LCD Module

Center of the screen
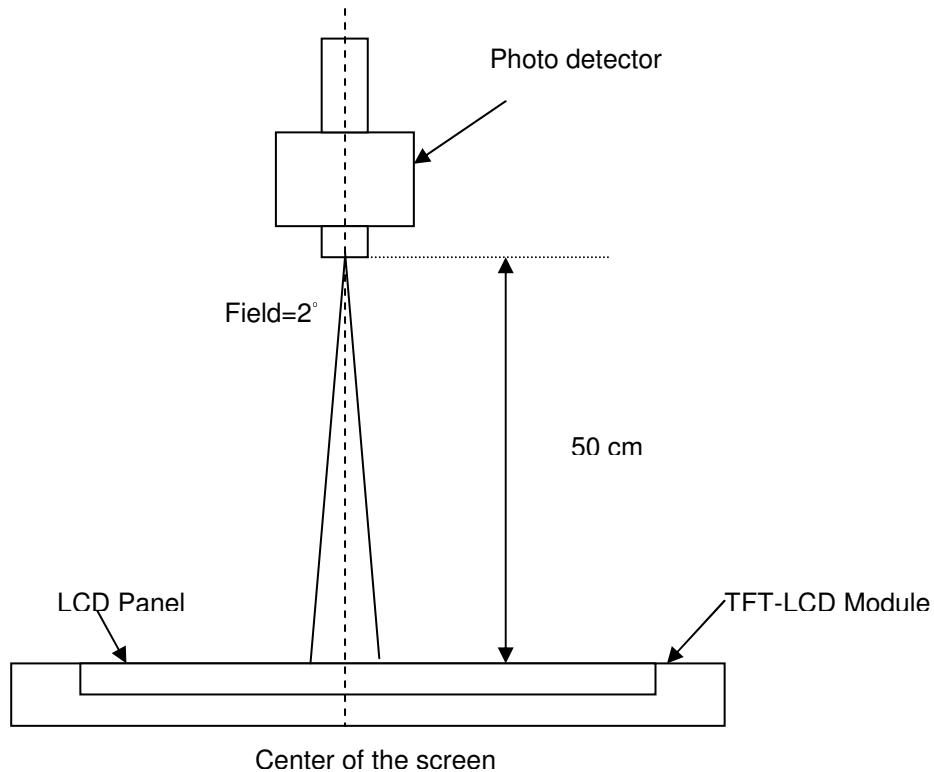
Note 5： Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points , Y_L = [L (1)+ L (2)+ L (3)+ L (4)+ L (5)] / 5

L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6： Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

$$\text{Contrast ratio (CR)}= \frac{\text{Brightness on the "White" state}}{\text{Brightness on the "Black" state}}$$

Note 7： Definition of Cross Talk (CT)

CT = | Y_B − Y_A | / Y_A × 100 (%)

Where

Y_A = Luminance of measured location without gray level 0 pattern (cd/m2)

Y_B = Luminance of measured location with gray level 0 pattern (cd/m2)
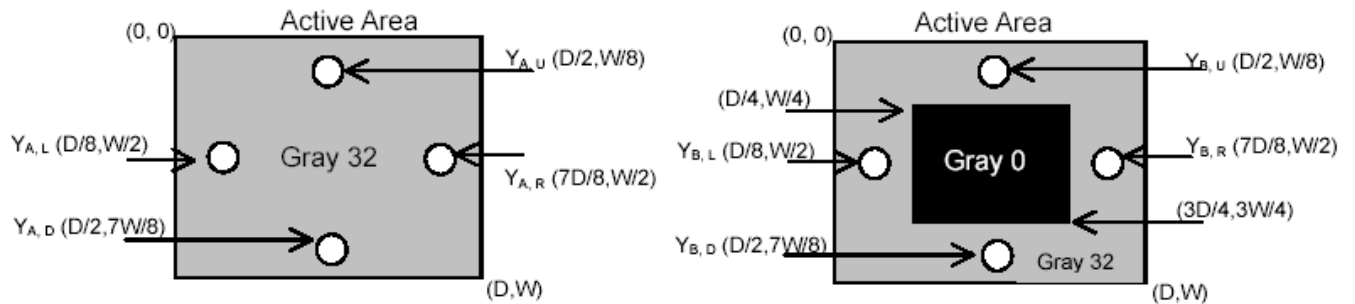
Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.
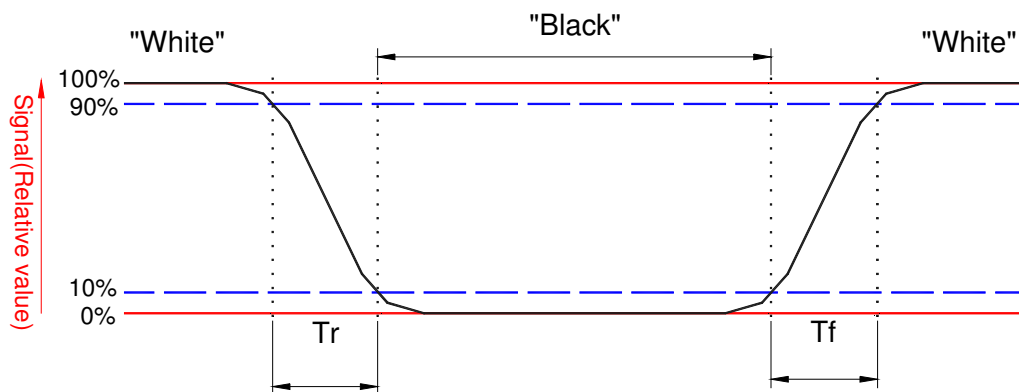
Note 9. Definition of viewing angle

Viewing angle is the measurement of contrast ratio $\geqq$ 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.
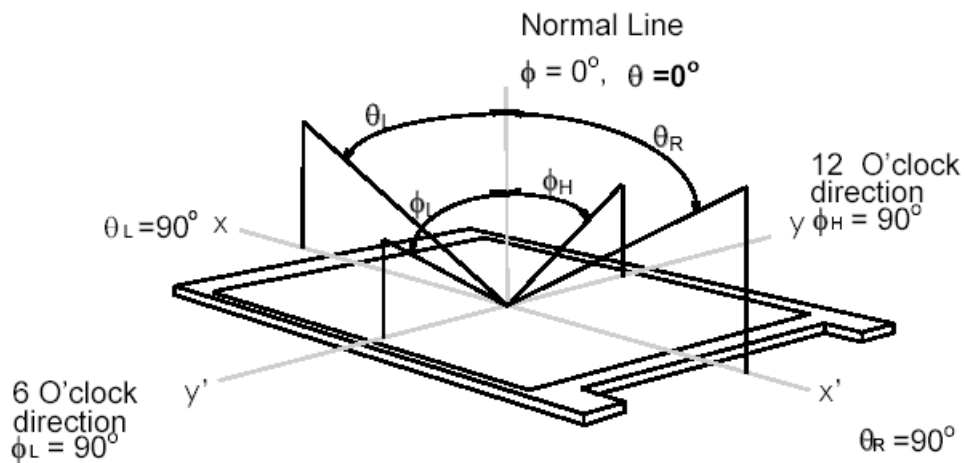
3. Functional Block Diagram

The following diagram shows the functional block of the 15.6 inches wide Color TFT/LCD 40 Pin (One CH/connector Module)
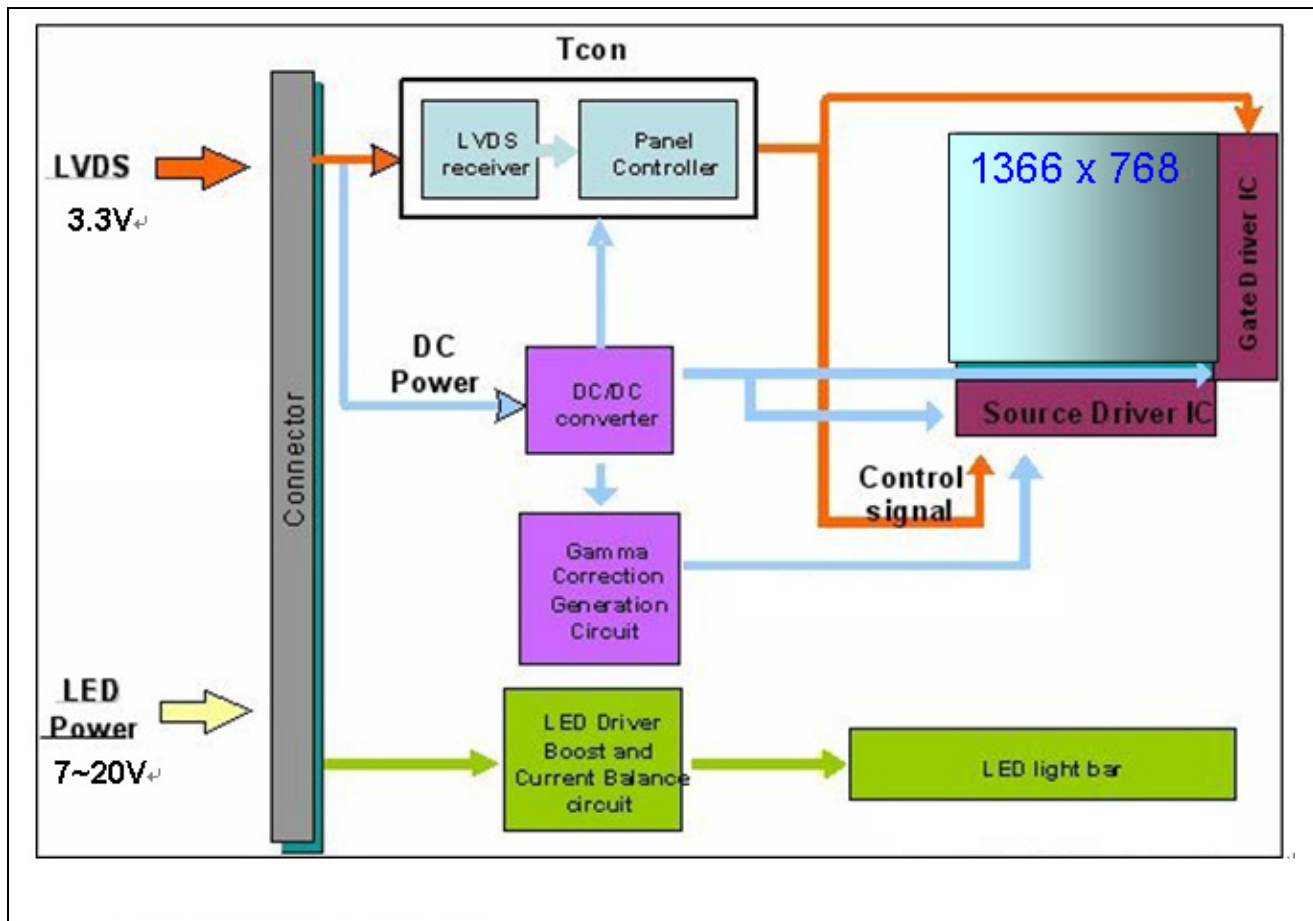
4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

Item	Symbol	Min	Max	Unit	Conditions
Operating	TOP	0	+50	[^{o}C]	Note 4
Operation Humidity	HOP	10	90	[%RH]	Note 4
Storage	TST	-20	+60	[^{o}C]	Note 4
Storage Humidity	HST	10	90	[%RH]	Note 4

Note 1: At Ta (25℃)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).
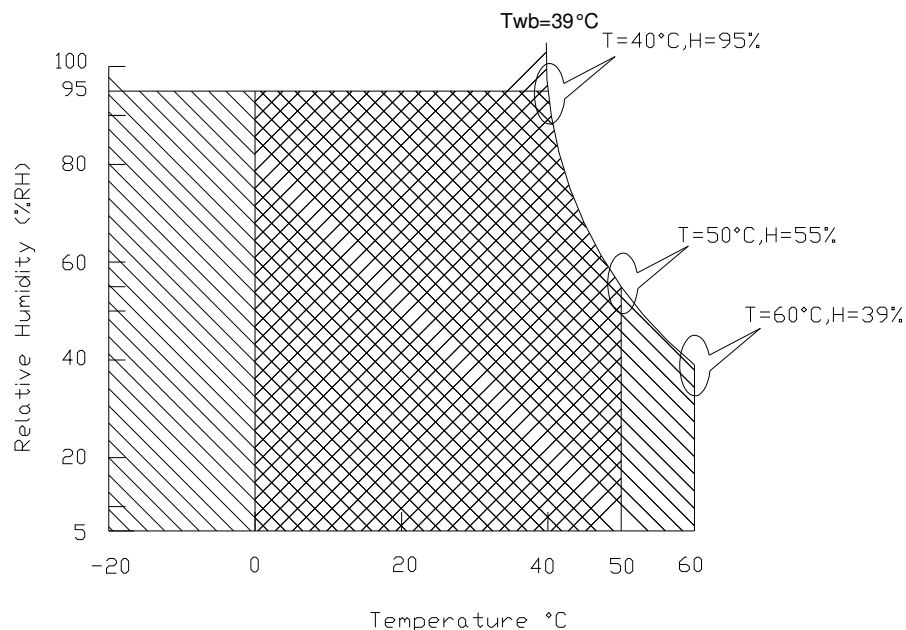
Operating Range   Storage Range

5. Electrical characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

Input power specifications are as follows;

The power specification are measured under 25℃ and frame frenquency under 60Hz

Symble	Parameter	Min	Typ	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	0.8	1.05	[Watt]	Note 1/2
IDD	IDD Current	-	303	400	[mA]	Note 1/2
IRush	Inrush Current	-	-	1500	[mA]	Note 3
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1 : Maximum Measurement Condition : Black Pattern
Note 2 : Typical Measurement Condition: Mosaic Pattern
Note 3 : Measure Condition
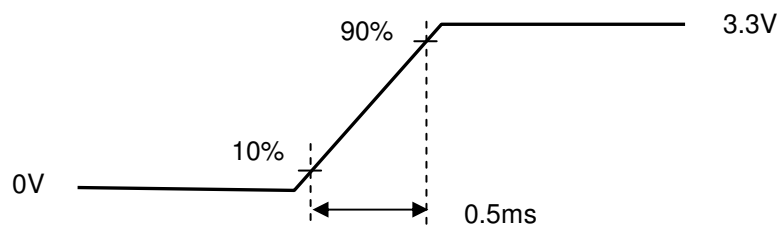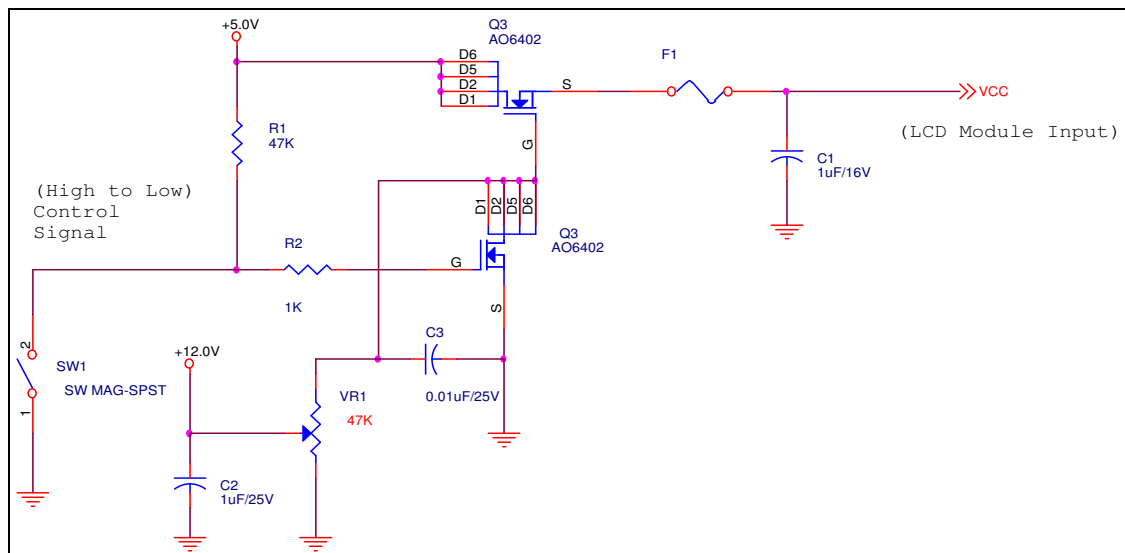
Vin rising time

5.1.2 Signal Electrical Characteristics

Input signals shall be low or High-impedance state when VDD is off.

It is recommended to refer the specifications of THC63LVDF84A (Thine Electronics Inc.) in detail.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
Vth	Differential Input High Threshold (Vcm=+1.2V)	-	100	[mV]
Vtl	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
Vcm	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform
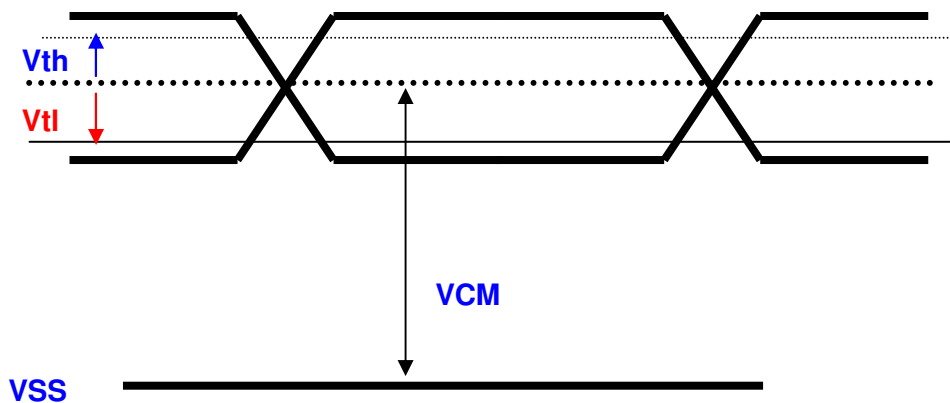
5.2 Backlight Unit

LED Parameter guideline for LED driving selection (Ref. Remark 1)

Parameter	Symbol	Min	Typ	Max	Units	Condition
LED Forward Voltage	V_F	3.0	--	3.4	[Volt]	(Ta=25℃)
LED Forward Current	I_F		20	30	[mA]	(Ta=25℃)
LED Power consumption	P_{LED}		4.07	4.13	[Watt]	(Ta=25℃) Note 1
LED Life-Time	N/A	10,000	--	--	Hour	(Ta=25℃) I_F=20 mA Note 2
Output PWM frequency	F_{PWM}	100	200	**20K**	Hz	
Duty ratio	--	**5**	--	100	%	

Note 1: Calculator value for reference
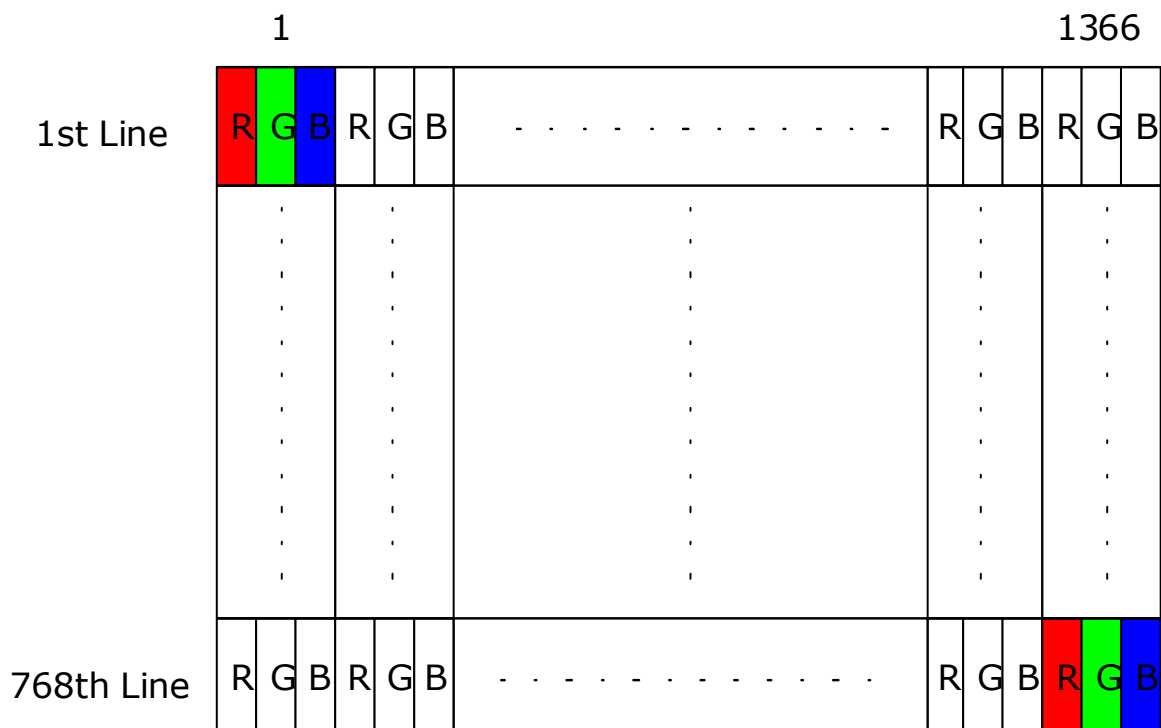
P_{LED} = V_F (Normal Distribution) * I_F (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.
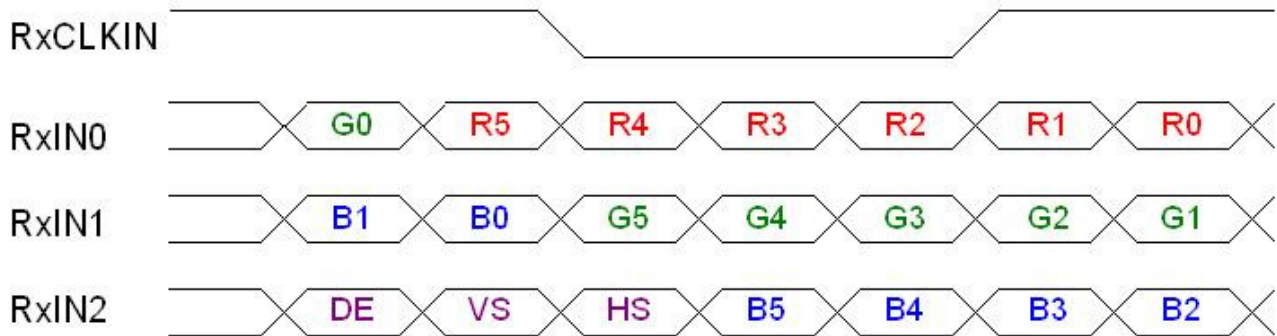
6. Signal Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

6.2 The input data format

Signal Name	Description	
R5 R4 R3 R2 R1 R0	Red Data 5 (MSB) Red Data 4 Red Data 3 Red Data 2 Red Data 1 Red Data 0 (LSB) Red-pixel Data	Red-pixel Data Each red pixel's brightness data consists of these 6 bits pixel data.
G5 G4 G3 G2 G1 G0	Green Data 5 (MSB) Green Data 4 Green Data 3 Green Data 2 Green Data 1 Green Data 0 (LSB) Green-pixel Data	Green-pixel Data Each green pixel's brightness data consists of these 6 bits pixel data.
B5 B4 B3 B2 B1 B0	Blue Data 5 (MSB) Blue Data 4 Blue Data 3 Blue Data 2 Blue Data 1 Blue Data 0 (LSB) Blue-pixel Data	Blue-pixel Data Each blue pixel's brightness data consists of these 6 bits pixel data.
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and DE signals. All pixel data shall be valid at the falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of RxCLKIN. When the signal is high, the pixel data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN .
HS	Horizontal Sync	The signal is synchronized to RxCLKIN .

Note: Output signals from any system shall be low or High-impedance state when VDD is off.

6.3 Integration Interface and Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

PIN#	Signal Name	Description
1	NC	No connection
2	VDD	Power Supply +3.3V
3	VDD	Power Supply +3.3V
4	VEDID	EDID +3.3V Power
5	Aging	Aging (AUO reserve)
6	CLK$_{EDID}$	EDID Clock Input
7	DATA$_{EDID}$	EDID Data Input
8	RxOIN0-	-LVDS Differential Data INPUT(Odd R0-R5,G0)
9	RxOIN0+	+LVDS Differential Data INPUT(Odd R0-R5,G0)
10	VSS	Ground
11	RxOIN1-	-LVDS Differential Data INPUT(Odd G1-G5,B0-B1)
12	RxOIN1+	+LVDS Differential Data INPUT(Odd G1-G5,B0-B1)
13	VSS	Ground
14	RxOIN2-	-LVDS Differential Data INPUT(Odd B2-B5,HS,VS,DE)
15	RxOIN2+	+LVDS Differential Data INPUT(Odd B2-B5,HS,VS,DE)
16	VSS	Ground
17	RxOCKIN-	-LVDS Odd Differential Clock INPUT
18	RxOCKIN+	-LVDS Odd Differential Clock INPUT
19	VSS	Ground
20	NC	No connection
21	NC	No connection
22	VSS	Ground
23	NC	No connection
24	NC	No connection
25	VSS	Ground
26	NC	No connection
27	NC	No connection
28	VSS	Ground
29	NC	No connection
30	NC	No connection
31	**VLED_GND**	**LED Ground**
32	**VLED_GND**	**LED Ground**
33	**VLED_GND**	**LED Ground**
34	NC	No connection

35	S_PWMIN	System PWM signal Input
36	BL_ON	LED Enable pin (+3V input, +5V tolerance)
37	NC	No connection
38	VLED	LED Power Supply 7V-20V
39	VLED	LED Power Supply 7V-20V
40	VLED	LED Power Supply 7V-20V

Note1: Start from right side

(BACK VIEW)

Connector

40 **1**

VLED **NC**
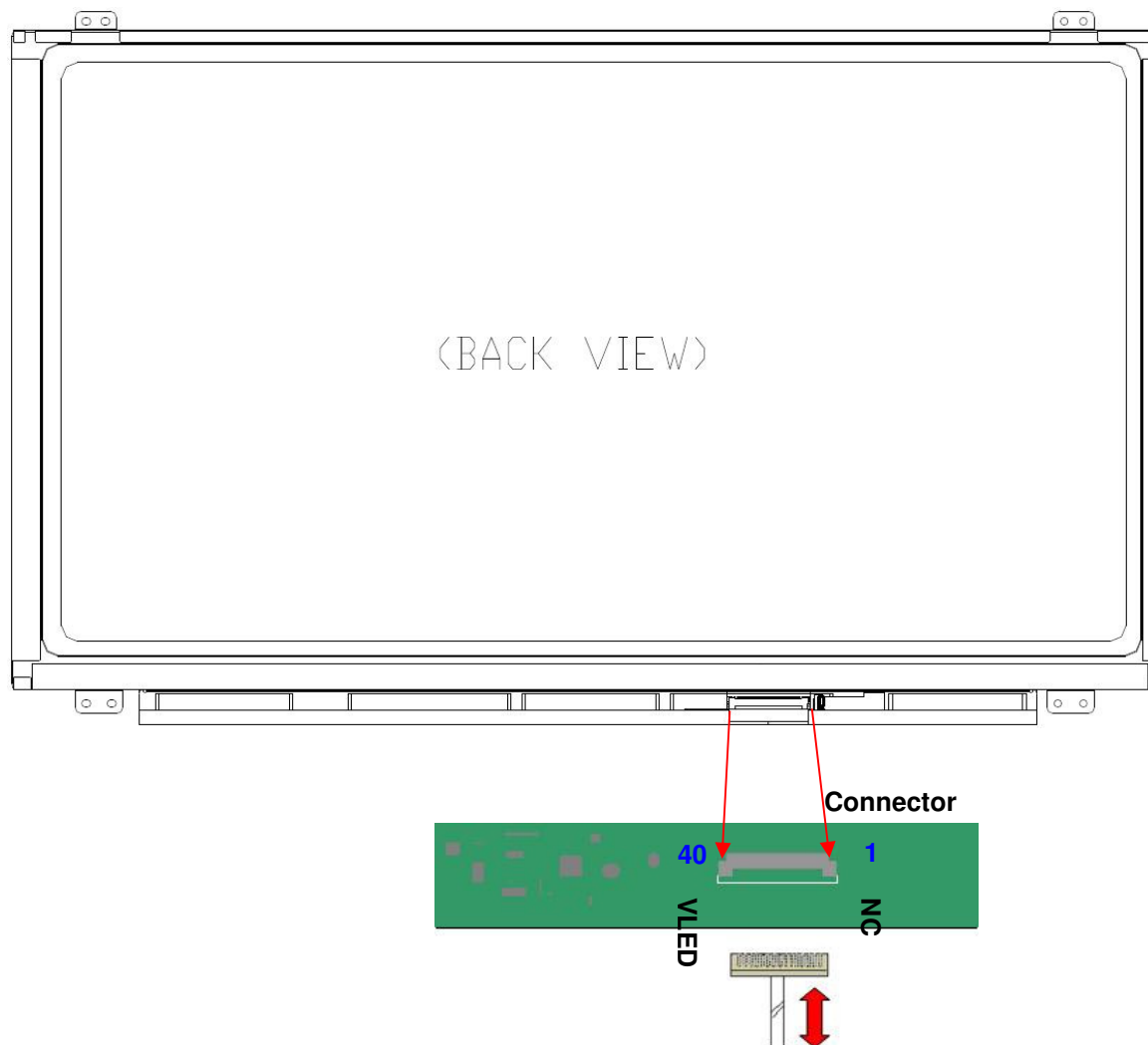
Note2: Input signals shall be low or High-impedance state when VDD is off.

Internal circuit of LVDS inputs are as following.
The module uses a 100ohm resistor between positive and negative data lines of each receiver input

Signal Input

LVDS Receiver

Pin No.

8   RxIN0-

R

9   RxIN0+

11 RxIN1-

R

12 RxIN1+

14 RxIN2-

R

15 RxIN2+

17 RxCLKIN-

R

18 RxCLKIN+

6.4 Interface Timing

6.4.1 Timing Characteristics

Basically, interface timings should match the 1366x768 /60Hz manufacturing guide line timing.
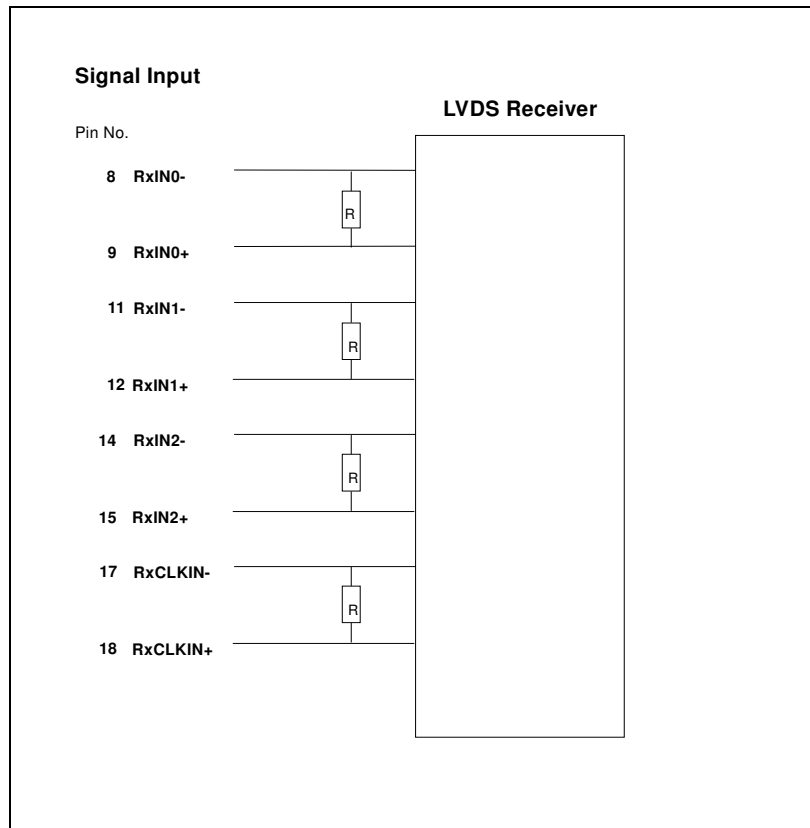
Parameter		Symbol	Min.	Typ.	Max.	Unit
Frame Rate		-	50	60	-	**Hz**
Clock frequency		$1/T_{Clock}$	65	70	80	**MHz**
Vertical Section	**Period**	T_V	780	808	-	**T_{Line}**
	Active	T_{VD}		768		
	Blanking	T_{VB}	12	23	-	
Horizontal Section	**Period**	T_H	1400	1440	-	**T_{Clock}**
	Active	T_{HD}		1366		
	Blanking	T_{HB}	34	160	-	

Note : DE mode only

6.4.2 Timing diagram
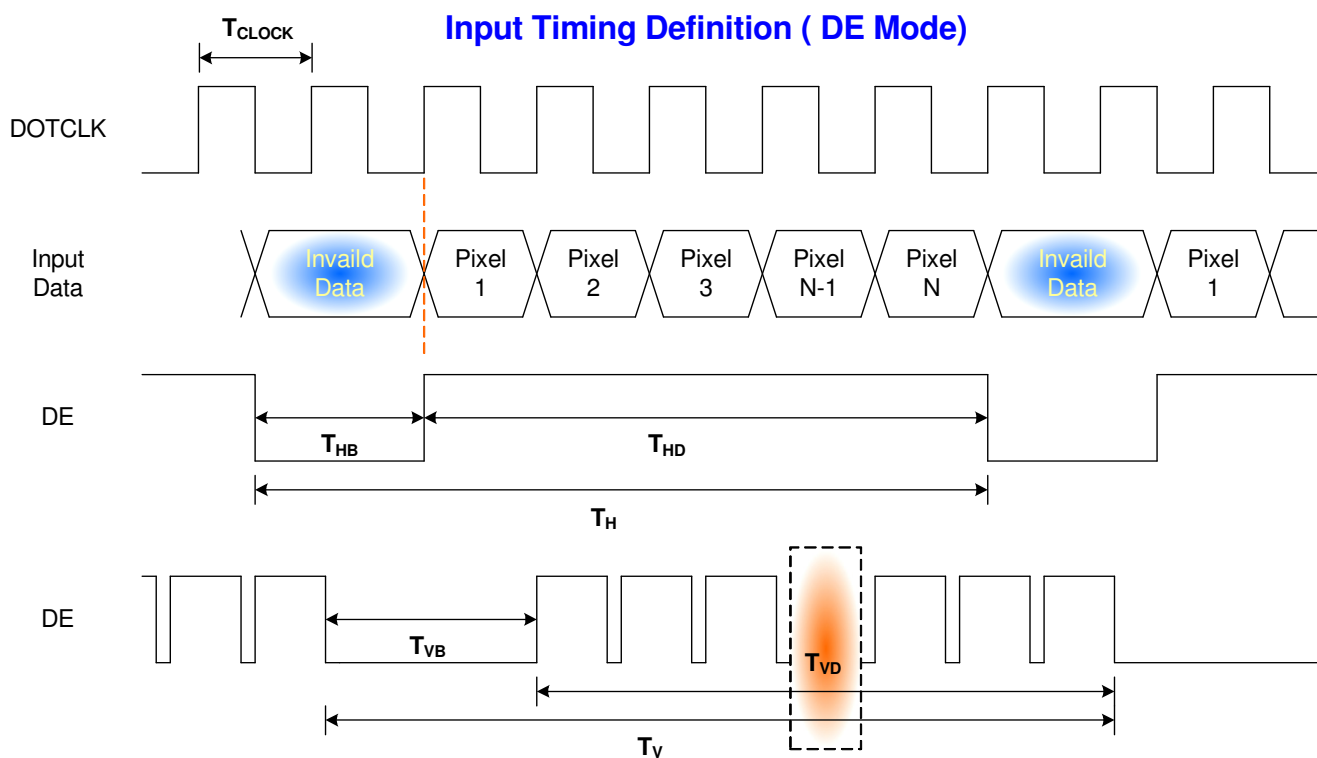
6.5 Power ON/OFF Sequence

VDD power on/off & LED On/Off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off
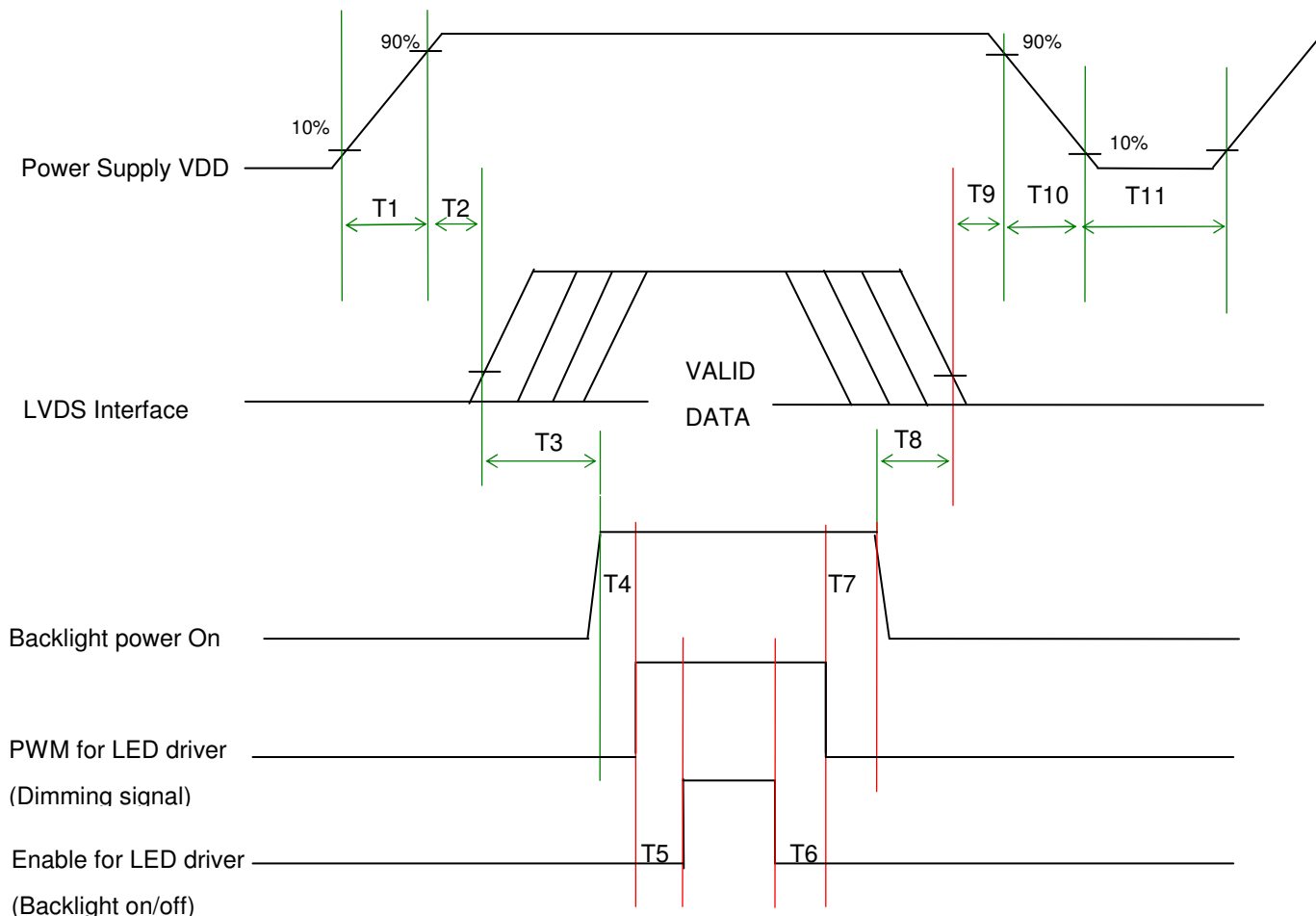
Parameter	Value (ms)		
	Min.	Typ.	Max.
T1	0.5	-	10
T2	5	-	50
T3	250	-	-
T4	10	-	-
T5	10	-	-
T6	10	-	-
T7	10	-	-
T8	250	-	-
T9	5	-	50
T10	0.5	-	10
T11	400	-	-

7. Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

7.1 TFT LCD Module

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or compatible
Type / Part Number	**IPEX 20455-040E-12A** or compatible
Mating Housing/Part Number	**IPEX 20453-040T-11** or compatible

8. LED Driving Specification

8.1 Connector Description

It is a intergrative interface and comibe into LVDS connector. The type and mating refer to section 7.

8.2 Pin Assignment

Ref. to 6.3

9. Vibration and Shock Test

9.1 Vibration Test

Test Spec:

- Test method: Non-Operation
- Acceleration: 1.5 G
- Frequency: 10 - 500Hz Random
- Sweep: 30 Minutes each Axis (X, Y, Z)

9.2 Shock Test Spec:

Test Spec:

- Test method: Non-Operation
- Acceleration: 220 G , Half sine wave
- Active time: 2 ms
- Pulse: X,Y,Z .one time for each side

10. Reliability

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV Air : ±15 KV	Note 1

Note1: According to EN 61000-4-2 , ESD class B: Some performance degradation allowed.

No data lost. Self-recoverable. No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%

11. Mechanical Characteristics

11.1 LCM Outline Dimension

Note: Prevention IC damage, IC positions not allowed any overlap over these areas.

359.5

15.78(BEZEL OPENNING)

101 (BEZEL OPENNING)

10.1 (BEZEL OPENNING)

217.5

206.5

(BACK VIEW)

15.1 (BEZEL OPENNING)

Shipping LABEL

BLU LABEL PRINT

(PCB EDGE)

1

PIN1

5.93

(TAPE EDGE)

DETAIL E
SCALE 2.000

SEE DETAIL F

122.15
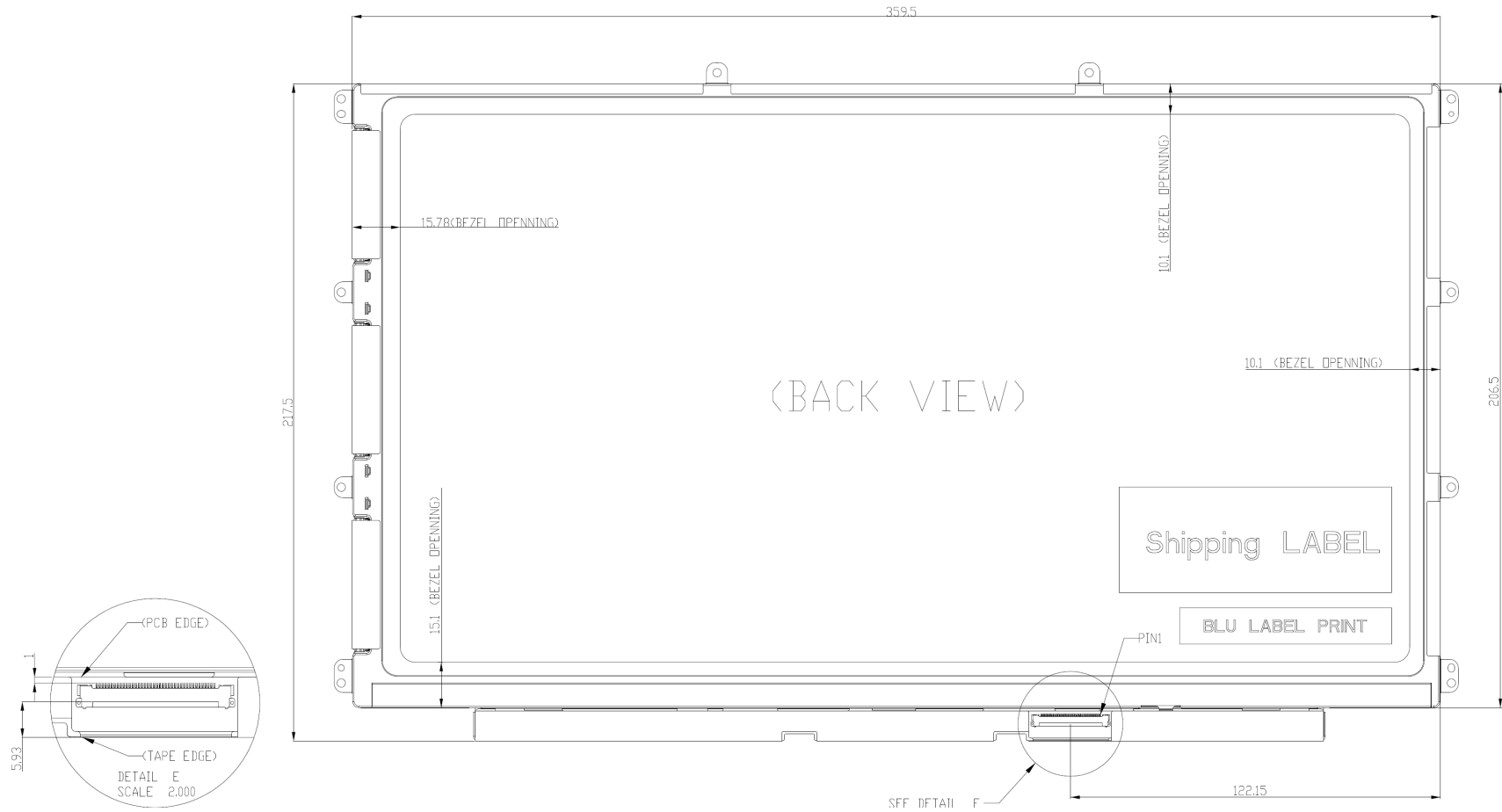
12. Shipping and Package

12.1 Shipping Label Format

Week code

Model name

Manufactured 05/52
Model No: B156XW03 V0
AU Optronics
MADE IN CHINA (S03)

c U L us
E204356

Pb

RoHS

15

H/W: 0A F/W:1

* XXXXXXXXXXX-XXXXX *

H/W

Manufactured 05/52
Model No: B156XW03 V0
AU Optronics
MADE IN CHINA (S03)

c U L us
E204356

Pb

RoHS

15

H/W: 1A F/W:1

* XXXXXXXXXXX-XXXXX *
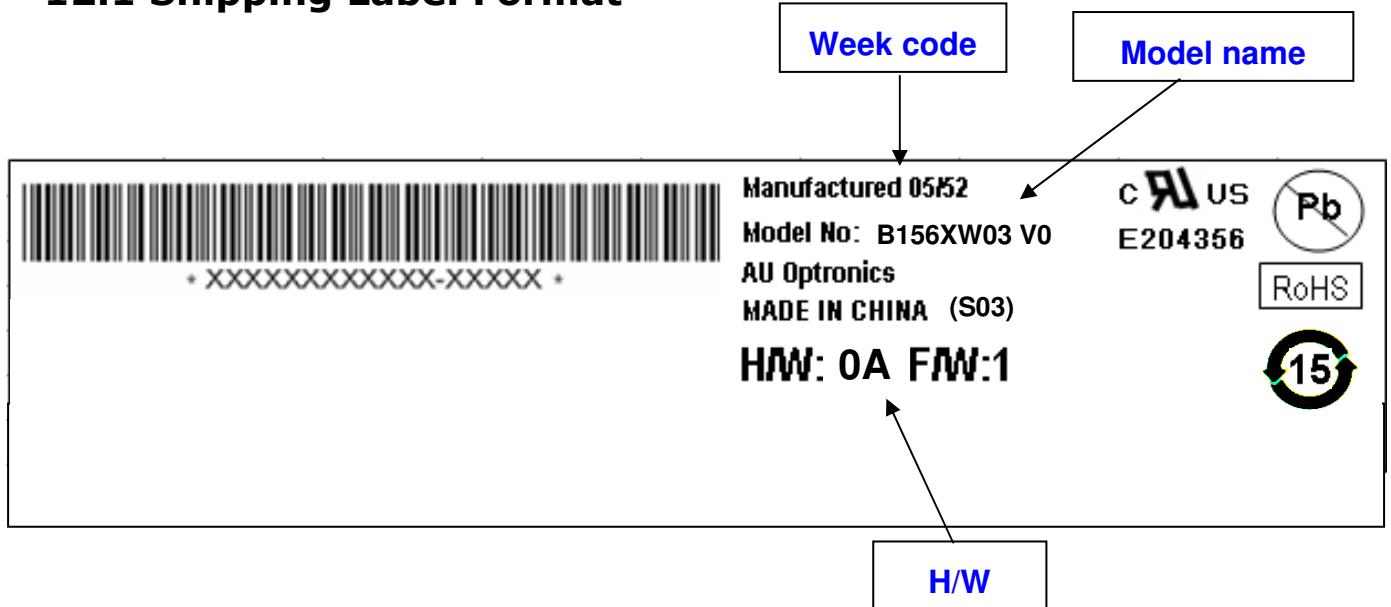
12.2 Carton package

TBD

12.3 Shipping package of palletizing sequence

TBD

13. Appendix: EDID description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	EC	11101100	236	
0B	hex, LSB first	30	00110000	48	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	01	00000001	1	
11	Year of manufacture	13	00010011	19	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	03	00000011	3	
14	**Video input def. (digital I/P, non-TMDS, CRGB)**	80	10000000	128	
15	**Max H image size (rounded to cm)**	22	00100010	34	

16	Max V image size (rounded to cm)	13	00010011	19	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	0A	00001010	10	
19	Red/green low bits (Lower 2:2:2:2 bits)	6B	01101011	107	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	2A	00101010	42	
1B	Red x (Upper 8 bits)	9D	10011101	157	
1C	Red y/ highER 8 bits	4C	01001100	76	
1D	Green x	42	01000010	66	
1E	Green y	84	10000100	132	
1F	Blue x	1C	00011100	28	
20	Blue y	0D	00001101	13	
21	White x	48	01001000	72	
22	White y	4C	01001100	76	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27		01	00000001	1	
28	Standard timing #2	01	00000001	1	
29		01	00000001	1	
2A	Standard timing #3	01	00000001	1	
2B		01	00000001	1	
2C	Standard timing #4	01	00000001	1	
2D		01	00000001	1	
2E	Standard timing #5	01	00000001	1	
2F		01	00000001	1	
30	Standard timing #6	01	00000001	1	
31		01	00000001	1	
32	Standard timing #7	01	00000001	1	
33		01	00000001	1	
34	Standard timing #8	01	00000001	1	
35		01	00000001	1	
36	Pixel Clock/10000 LSB	58	01011000	88	
37	Pixel Clock/10000 USB	1B	00011011	27	
38	Horz active Lower 8bits	56	01010110	86	
39	Horz blanking Lower 8bits	67	01100111	103	
3A	Horz Act:Horz Blnk Upper 4:4 bits	50	01010000	80	
3B	Vertical Active Lower 8bits	00	00000000	0	

3C	Vertical Blanking Lower 8bits	1A	00011010	26	
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	30	00110000	48	
3E	Horz Sync. Offset	30	00110000	48	
3F	Horz Sync.Width	20	00100000	32	
40	Vert Sync.Offset : Vert Sync.Width	36	00110110	54	
41	Horz & Vert Sync Offset/Width Upper 2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	58	01011000	88	
43	Vertical Image Size Lower 8bits	C1	11000001	193	
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16	
45	Horizontal Border (zero for internal LCD)	00	00000000	0	
46	Vertical Border (zero for internal LCD)	00	00000000	0	
47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	00011000	24	
48	Detailed timing/monitor	00	00000000	0	
49	descriptor #2	00	00000000	0	
4A		00	00000000	0	
4B		0F	00001111	15	
4C		00	00000000	0	
4D		00	00000000	0	
4E		00	00000000	0	
4F		00	00000000	0	
50		00	00000000	0	
51		00	00000000	0	
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	
58		00	00000000	0	
59		20	00100000	32	
5A	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	
5D		FE	11111110	254	
5E		00	00000000	0	
5F	Manufacture	41	01000001	65	A
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	O
62		0A	00001010	10	

63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	
6E		00	00000000	0	
6F		FE	11111110	254	
70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	B
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	35	00110101	53	5
74	Manufacture P/N	36	00110110	54	6
75	Manufacture P/N	58	01011000	88	X
76	Manufacture P/N	57	01010111	87	W
77	Manufacture P/N	30	00110000	48	0
78	Manufacture P/N	33	00110011	51	3
79	Manufacture P/N	20	00100000	32	
7A	Manufacture P/N	56	01010110	86	V
7B	Manufacture P/N	30	00110000	48	0
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	4A	01001010	74	